

APPLICATION DATA SHEET

Electronic Version v14
Stylesheet Version v14.1

JC12 Rec'd PCT/PTC 03 OCT 2005

*Applicant Information:*Inventor 1:

Applicant Authority Type:	Inventor
Citizenship:	DE
Given Name:	Andreas
Family Name:	LINDEMANN
City of Residence:	Lampertheim
Country of Residence:	DE
Address-1 of Mailing Address:	Martin-Karcher Strasse 30
Address-2 of Mailing Address:	
City of Mailing Address:	Lampertheim
State of Mailing Address:	
Postal Code of Mailing Address:	68623
Country of Mailing Address:	DE
Phone:	
Fax:	
E-mail:	

Correspondence Information:

Customer Number:	23405	*23405*
------------------	-------	---------

Application Information:

Title of Invention: ENCAPSULATED POWER SEMICONDUCTOR ASSEMBLY
Application Type: regular, utility
Attorney Docket Number: 1477.021

Botanic Information:

Publication Information:

Suggested Figure for Publication - 1
Suggested Classification -
Suggested Technology Center -

Total Number of Drawing Sheets - 2

Representative Information:

practitioner(s) at Customer Number:

23405 *23405*

as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Domestic Priority Information:

This is a National Stage of WO application number PCT/EP2004/003750, filed 2004-08-04, now Published.

Foreign Priority Information:

Doc.No:103 16 136.8; Country - DE; Date: 2003-04-09 us-priority-claimed

Assignee Information:

Assignee 1:

Organization Name: IXYS SEMICONDUCTOR GMBH

Address-1 of Mailing Address: Edisonstrasse 15

Address-2 of Mailing Address:

City of Mailing Address: Lampertheim

State of Mailing Address:

Postal Code of Mailing Address: 68623

Country of Mailing Address: DE

Phone:

Fax:

E-mail: